\*95706-X X X X

LEAD FREE

└─ SOLDER TAIL

- STAND OFF

MOUNTING STYLE

0: R/A

5 : R/A

0 : 0mm

1 : 4mm

2 : 5mm

4 : 2mm

1 2

0 : TOP MOUNTING

5 : BOTTOM MOUNTING

1 : SMT STAGGERED

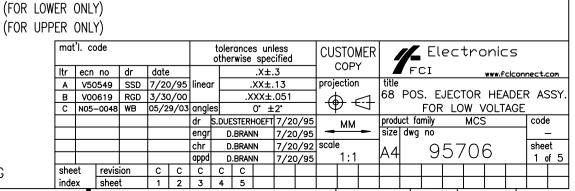
2 : SMT IN LINE

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PRODUCT NO.	STAND OFF	001.050 #411	DIM "P"	CUEET NO	MOUNTING STYLE
95706-XXX	DIM"M"(mm)	SOLDER TAIL	(mm)	SHEET NO.	TO PCB
000	0	R/A	2.8		TOD 1101111T
000LF	0	R/A	2.8		TOP MOUNT 95706-0XX
001	0	SMT STAGGERED	<del></del>	NO.2	- BLACK COLOR
002	0	SMT IN LINE			
010	4	R/A	2.8		▎ <del>▗</del> ▎ <del>▗</del> ───○┐╏ │
020	5	R/A	2.8		/////////PCB/////////
040	2	R/A	2.5		
010LF	4	R/A	2.8	NO.3	
020LF	5	R/A	2.8		
040LF	2	R/A	2.5		
500	0	R/A	2.8		
500LF	0	R/A	2.8		
501	0	SMT STAGGERED		NO.4	BOTTOM MOUNT
502	0	SMT IN LINE			95706-5XX
510	4	R/A	2.8		
520	5	R/A	2.8		d  •
540	2	R/A	2.5	NO.5	NATURAL(WHITE)COLOR
510LF	4	R/A	2.8	10.5	
520LF	5	R/A	2.8		
540LF	2	R/A	2.5		

2

1 |



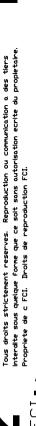
3

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STATUS:Released26 Printed: Feb 06, 2008

(FOR LOWER & SINGLE)

(FOR LOWER ONLY)



- ① TRUE POSITION IS A FREE GRID TO PIN PATTERN ITSELF
- SEE TA-946 FOR PCB LAYOUT

MATERIAL

PRODUCT NO.

HOUSING : LCP UL94V-0 BLACK PIN : PHOSPHOR BRONZE

FINISH PIN

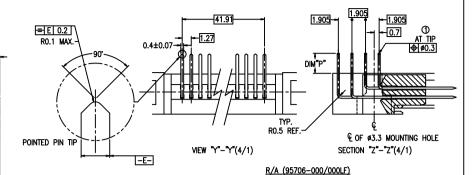
UNDER PLATING: 0.5µm MIN. Ni CONTACT AREA : 0.1 um MIN. Au

OVER 0.5µm MIN. Pd-Ni
SOLDER AREA(TIN LEAD OPTION): 2.5µm MIN. Sn-Pb
SOLDER AREA(LEAD FREE OPTION): 2.5µm MIN. PURE TIN

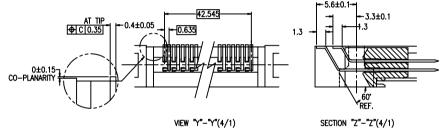
SEQUENCE PIN ASSIGNMENT

ı 🔨		DIM "L"	
	4.25±0.1	3.5±0.1	5.0±0.1
PIN No.	OTHERS	36.67	1,17,34 35.51.68

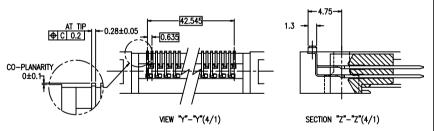
- 6 GENERAL TOLERANCE: ±0.3
- 7 IF LEAD FREE P/N. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE SOLDER TAIL: SMT-IL, SMT-STG CAN RESIST 40 SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN.
  - SOLDER TAIL: R/A CAN RESIST 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.00MM MINIMUM THICK CIRCUIT BOARD.
- IF LEAD FREE P/N PACKAGING MEETS GS-14-920 SPECIFICATION



3



SMT STAGGERED (95706-001)



SMT IN LINE (95706-002)

mat'l. code						tolerances unless otherwise specified							CUSTOMER			Electronics								
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					chr D.BRANN 7/20/9:		0/92	scale		ا ۸ ۸	4 95706 [					sheet								
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2

\_C\_ 5.8 ±8.2 →

7.2 REF

-34 pin

-B-

-A-

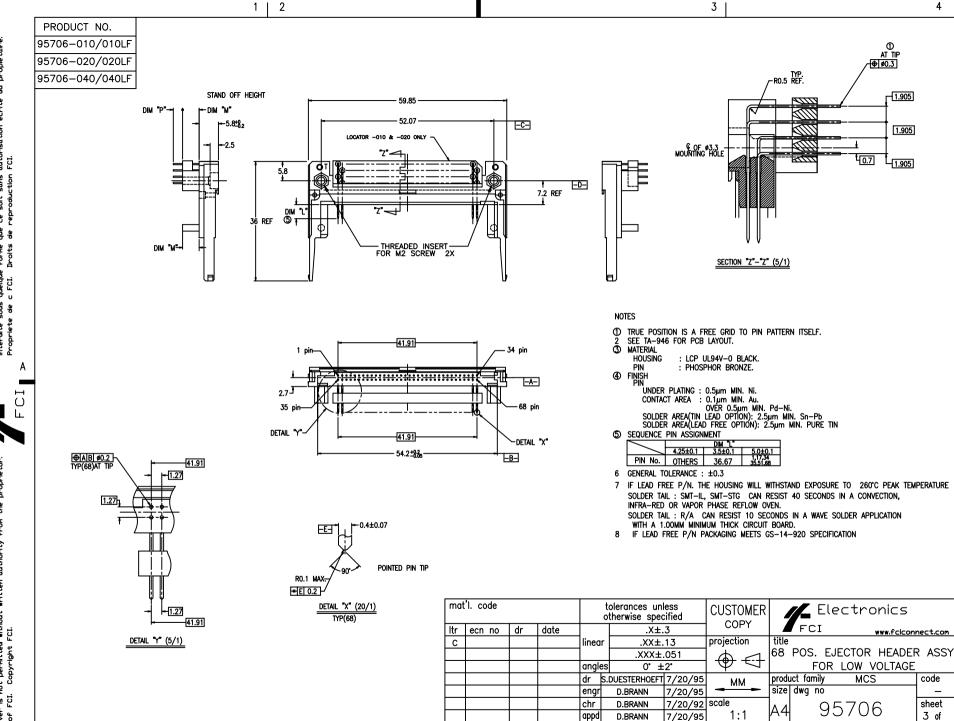
-68 pin

41.91

2.5→

1 |

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ACAD

revision sheet

index

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PRODUCT NO.

95706-500/500LF

95706-501

95706-502

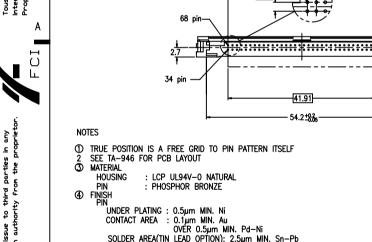






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S SEQUENCE PIN ASSIGNMENT

OTHERS 6 GENERAL TOLERANCE: ±0.3

PIN No.

SOLDER AREA(TIN LEAD OPTION): 2.5µm MIN. Sn-Pb SOLDER AREA(LEAD FREE OPTION): 2.5µm MIN. PURE TIN

4.25±0.1 | 3.5±0.1 | 5.0±0

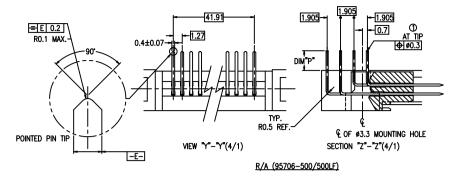
INFRA-RED OR VAPOR PHASE REFLOW OVEN.

WITH A 1.00MM MINIMUM THICK CIRCUIT BOARD. 8 IF LEAD FREE P/N PACKAGING MEETS GS-14-920 SPECIFICATION

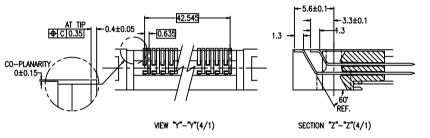
36.67

36 REF.

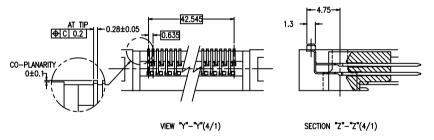
(5) T



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SMT STAGGERED (95706-501)



SMT IN LINE (95706-502)

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						angle	es	0° ±2°							FOR LOW VOLTAGE									
						dr	S.DUE	DUESTERHOEFT 7/20/95		мм		product family				MCS	5		code	•				
					engr	D	D.BRANN 7/20/95 D.BRANN 7/20/92		<del>- '''''-</del>			size	dwg no						-	-				
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7 IF LEAD FREE P/N. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE SOLDER TAIL: SMT-IL, SMT-STG CAN RESIST 40 SECONDS IN A CONVECTION.

SOLDER TAIL: R/A CAN RESIST 10 SECONDS IN A WAVE SOLDER APPLICATION

2

59.85

52.07

THREADED INSERT-

41.91

**⊕** A B Ø0.2

TYP(68) AT TIP

41.91

FOR M2 SCREW 2X

"Z"—

\_C\_ 5.8 ±8.2 --

7.2 REF

35 pin

-B-

1 |

ACAD

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